

L Number	Hits	Search Text	DB	Time stamp
14	361	324/755.ccls. and (chip or die)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/22 12:27
15	292	(324/755.ccls. and (chip or die)) and (@ad<20000223)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/22 13:03
16	18	(324/755.ccls. and (chip or die)) and (conduct\$3 near elastomer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/22 12:38
17	29	conductive with (carbon near elastomer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/22 13:31
18	118	(conductive near elastomer) with (gold or nickel or silver or steel or au or ag or ni)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/22 13:34
19	49	((conductive near elastomer) with (gold or nickel or silver or steel or au or ag or ni)) and (chip or die)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/22 12:51
21	65	((conductive near elastomer) with (carbon or gold or nickel or silver or steel or au or ag or ni)) and (test or burn or kgd)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/22 13:47
22	53	((conductive near elastomer) with (carbon or gold or nickel or silver or steel or au or ag or ni)) and (test or burn or kgd)) and (@ad<20000223)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/22 13:16
24	20	((conductive near elastomer) with (carbon or gold or nickel or silver or steel or au or ag or ni)) and 324/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/22 13:19
25	2	((conductive near elastomer) with (carbon or gold or nickel or silver or steel or au or ag or ni)) with (lid or cap or package)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/22 13:21
26	2	((conductive near elastomer) with (carbon or gold or nickel or silver or steel or au or ag or ni)) with (lid or cap or package or head)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/22 13:21
23	18		USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/22 13:25
20	240	(conductive near elastomer) with (carbon or gold or nickel or silver or steel or au or ag or ni)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/22 13:28
27	2248	(variable adj resistance) and (test or burn or kgd)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/22 13:30

28	519	((variable adj resistance) and (test or burn or kgd)) and (chip or die)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/22 13:32
29	70	((variable adj resistance) and (test or burn or kgd)) and elastomer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/22 13:32
30	0	(chip or die) near((conductive near elastomer) with (gold or nickel or silver or steel or au or ag or ni))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/22 13:36
31	6	(chip or die) with((conductive near elastomer) with (gold or nickel or silver or steel or au or ag or ni))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/22 13:46
32	38	((conductive near elastomer) with (carbon or gold or nickel or silver or steel or au or ag or ni)) and package	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/22 13:41
33	87	(chip or die) with (conductive near elastomer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/22 13:46
34	26	((chip or die) with (conductive near elastomer)) and (test or burn or kgd)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/22 13:48